



PATENT

~~IN THE UNITED STATES PATENT AND TRADEMARK OFFICE~~

Application No.: 10/647,297 Group Art Unit: 1771
Filing Date: August 26, 2003 Examiner: Hai Vo
Applicants: Hyun HUH et al.
Title: Polishing Pad Containing Embedded Liquid Microelements
and Method of Manufacturing the Same
Attorney Docket: 47881-000003/US

Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314
Mail Stop Amendment

RESPONSE

Sir:

In response to the Office Action mailed December 28, 2006, the period for response having been extended two (2) months to May 28, 2007, the following remarks are respectfully submitted in connection with the above-identified application.

Listing of the Claims begins on page 2 of this Amendment.

Remarks begin on page 8 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	16	-	31	=	0
Independent	1	-	3	=	0

05/30/2007 SZEWDIE1 00000124 10647297
01 FC:2252 225.00 OP